

- Fully Matches Parameters for SCSI Alternative 2 Active Termination
- Fixed 2.85-V Output
- $\pm 1.5\%$ Maximum Output Tolerance at $T_J = 25^\circ\text{C}$
- 1-V Maximum Dropout Voltage
- 500-mA Output Current
- $\pm 3\%$ Absolute Output Variation
- Internal Overcurrent-Limiting Circuitry
- Internal Thermal-Overload Protection
- Internal Overvoltage Protection

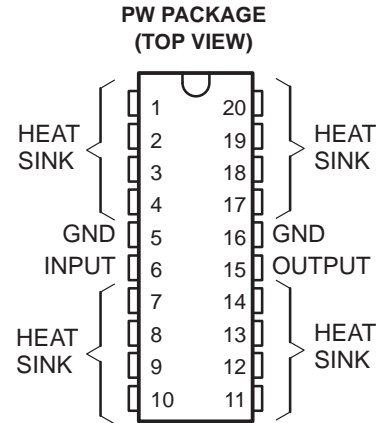
description

The TL2217-285 is a low-dropout (1 V) fixed-voltage regulator specifically designed for small computer systems interface (SCSI) alternative 2 active signal termination. The TL2217-285 1-V maximum dropout ensures compatibility with existing SCSI systems, while providing a wide TERMPWR voltage range. At the same time, the $\pm 1.5\%$ initial tolerance on its 2.85-V output voltage ensures a tighter line-driver current tolerance, thereby increasing system noise margin.

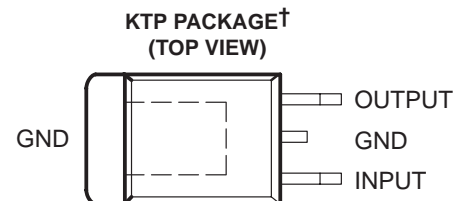
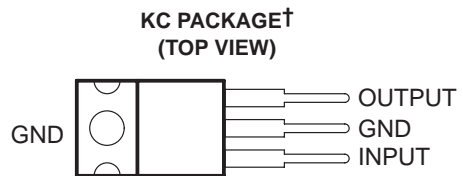
The fixed 2.85-V output voltage of TL2217-285 supports the SCSI alternative 2 termination standard, while reducing system power consumption. The 1-V maximum dropout voltage brings increased TERMPWR isolation, making the device ideal for battery-powered systems. The TL2217-285, with internal current limiting, overvoltage protection, ESD protection, and thermal protection, offers designers enhanced system protection and reliability.

When configured as a SCSI active terminator, the TL2217-285 low-dropout regulator eliminates the 220- Ω and 330- Ω resistors required for each transmission line with a passive termination scheme, reducing significantly the continuous system-power drain. When placed in series with 110- Ω resistors, the device matches the impedance level of the transmission cable and eliminates reflections.

The TL2217-285 is characterized for operation over the virtual junction temperature range of 0°C to 125°C .



HEAT SINK – These pins have an internal resistive connection to ground and should be grounded or electrically isolated.



† The GND terminal is in electrical contact with the mounting base.



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**TEXAS
INSTRUMENTS**

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TL2217-285

FIXED-VOLTAGE REGULATORS

FOR SCSI ACTIVE TERMINATION

SLVS066F – NOVEMBER 1991 – REVISED JULY 1999

AVAILABLE OPTIONS

T _J	PACKAGED DEVICES			CHIP FORM (Y)
	PLASTIC POWER (KC)	PLASTIC FLANGE MOUNT (KTP)	SURFACE MOUNT (PW)	
0°C to 125°C	TL2217-285KC	TL2217-285KTP	TL2217-285PWR	TL2217-285Y

The KTP and PW packages are only available taped and reeled. Add the suffix R to the device type (e.g., TL2217-285KTPR). Chip forms are tested at 25°C.

absolute maximum ratings over operating virtual junction temperature range (unless otherwise noted)[†]

Continuous input voltage, V _I	7.5 V
Operating virtual junction temperature range, T _J	–55°C to 150°C
Package thermal impedance, θ_{JA} (see Notes 1 and 2): KC package	22°C/W
KTP package	28°C/W
PW package	83°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds	260°C
Storage temperature range, T _{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Maximum power dissipation is a function of T_{J(max)}, θ_{JA} , and T_A. The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_{J(max)} - T_A) / \theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability. Due to variations in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection may be activated at power levels slightly above or below the rated dissipation.
2. The package thermal impedance is calculated in accordance with JEDEC 51, except for through-hole packages, which use a trace length of zero.

recommended operating conditions

		MIN	MAX	UNIT
Input voltage, V _I		3.85	5.5	V
Output current, I _O		0	500	mA
Operating virtual junction temperature range, T _J	TL2217-285	0	125	°C



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electrical characteristics over recommended operating conditions, $V_I = 4.5\text{ V}$, $I_O = 500\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		TL2217-285			UNIT
			MIN	TYP	MAX	
Output voltage	$I_O = 20\text{ mA to }500\text{ mA}, \quad V_I = 3.85\text{ V to }5.5\text{ V}$	$T_J = 25^\circ\text{C}$	2.81	2.85	2.89	V
		$T_J = 0^\circ\text{C to }125^\circ\text{C}$	2.765		2.935	
Input voltage regulation	$V_I = 3.85\text{ V to }5.5\text{ V}$			5	15	mV
Ripple rejection	$f = 120\text{Hz}, \quad V_{\text{ripple}} = 1\text{ V}_{\text{PP}}$			-62		dB
Output voltage regulation	$I_O = 20\text{ mA to }500\text{ mA}$			5	30	mV
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$			500		μV
Dropout voltage					1	V
Bias current	$I_O = 0$			2	5	mA
	$I_O = 27\text{ mA}, \text{ equivalent } 1\text{ line asserted}$			3	6	
	$I_O = 500\text{ mA}, \text{ equivalent } 18\text{ lines asserted (8 bit)}$			26	49	

† Pulse-testing techniques are used to maintain the virtual junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a $0.1\text{-}\mu\text{F}$ capacitor across the input and a $22\text{-}\mu\text{F}$ tantalum capacitor with equivalent series resistance of $1.5\ \Omega$ on the output.

electrical characteristics over recommended operating conditions, $V_I = 4.5\text{ V}$, $I_O = 500\text{ mA}$, $T_J = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	TL2217-285Y			UNIT
		MIN	TYP	MAX	
Output voltage	$I_O = 20\text{ mA to }500\text{ mA}$, $V_I = 3.85\text{ V to }5.5\text{ V}$	2.81	2.85	2.89	V
Input voltage regulation	$V_I = 3.85\text{ V to }5.5\text{ V}$		5	15	mV
Ripple rejection	$f = 120\text{ Hz}$, $V_{\text{ripple}} = 1\text{ V}_{\text{PP}}$		-62		dB
Output voltage regulation	$I_O = 20\text{ mA to }500\text{ mA}$		5	30	mV
Output noise voltage	$f = 10\text{ Hz to }100\text{ kHz}$		500		μV
Dropout voltage	$I_O = 500\text{ mA}$			1	V
Bias current	$I_O = 0$		2	5	mA
	$I_O = 27\text{ mA}$, equivalent 1 line asserted		3	6	
	$I_O = 500\text{ mA}$, equivalent 18 lines asserted (8 bit)		26	49	

† Pulse-testing techniques are used to maintain the virtual junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a $0.1\text{-}\mu\text{F}$ capacitor across the input and a $22\text{-}\mu\text{F}$ tantalum capacitor with equivalent series resistance of $1.5\ \Omega$ on the output.

TL2217-285

FIXED-VOLTAGE REGULATORS FOR SCSI ACTIVE TERMINATION

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COMPENSATION-CAPACITOR SELECTION INFORMATION

The TL2217-285 is a low-dropout regulator. This means that the capacitance loading is important to the performance of the regulator because it is a vital part of the control loop. The capacitor value and the equivalent series resistance (ESR) both affect the control loop and must be defined for the load range and the temperature range. Figure 3 and Figure 4 can be used to establish the capacitance value and ESR range for best regulator performance.

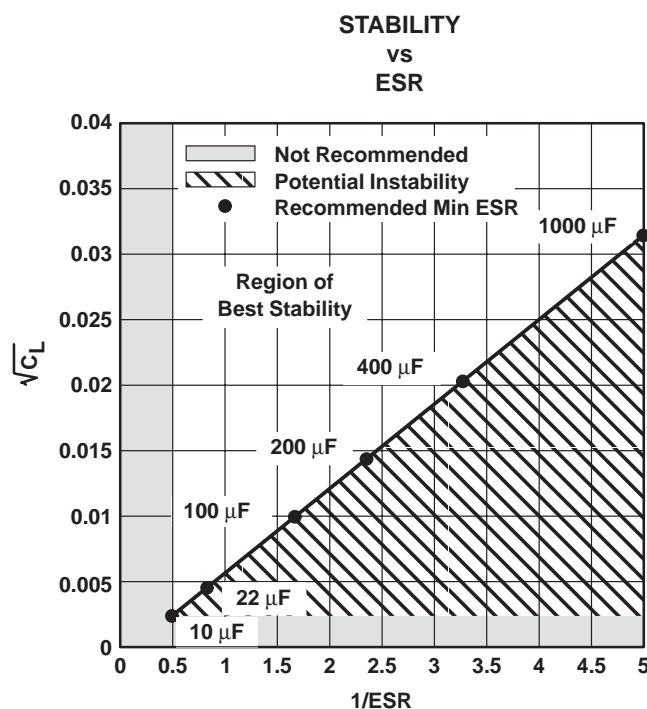
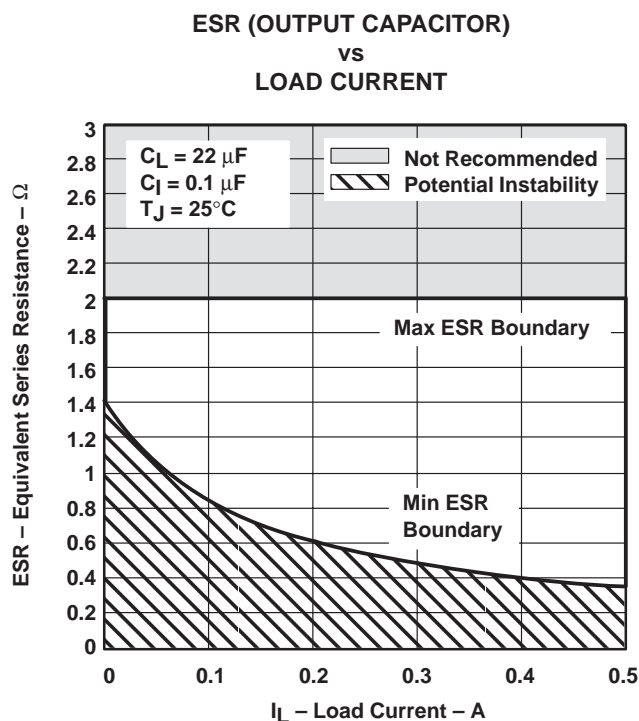


Figure 2

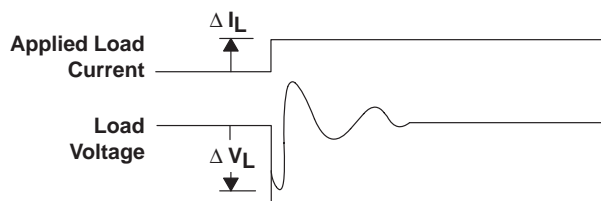


Figure 1

APPLICATION INFORMATION

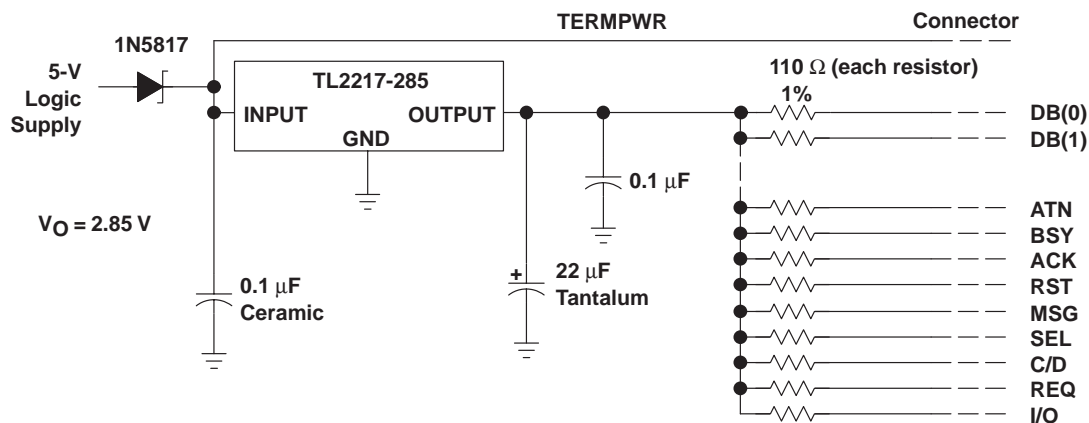


Figure 3. Typical Application Schematic

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TL2217-285KC	OBSOLETE	TO-220	KC	3		TBD	Call TI	Call TI
TL2217-285PWR	OBSOLETE	TSSOP	PW	20		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

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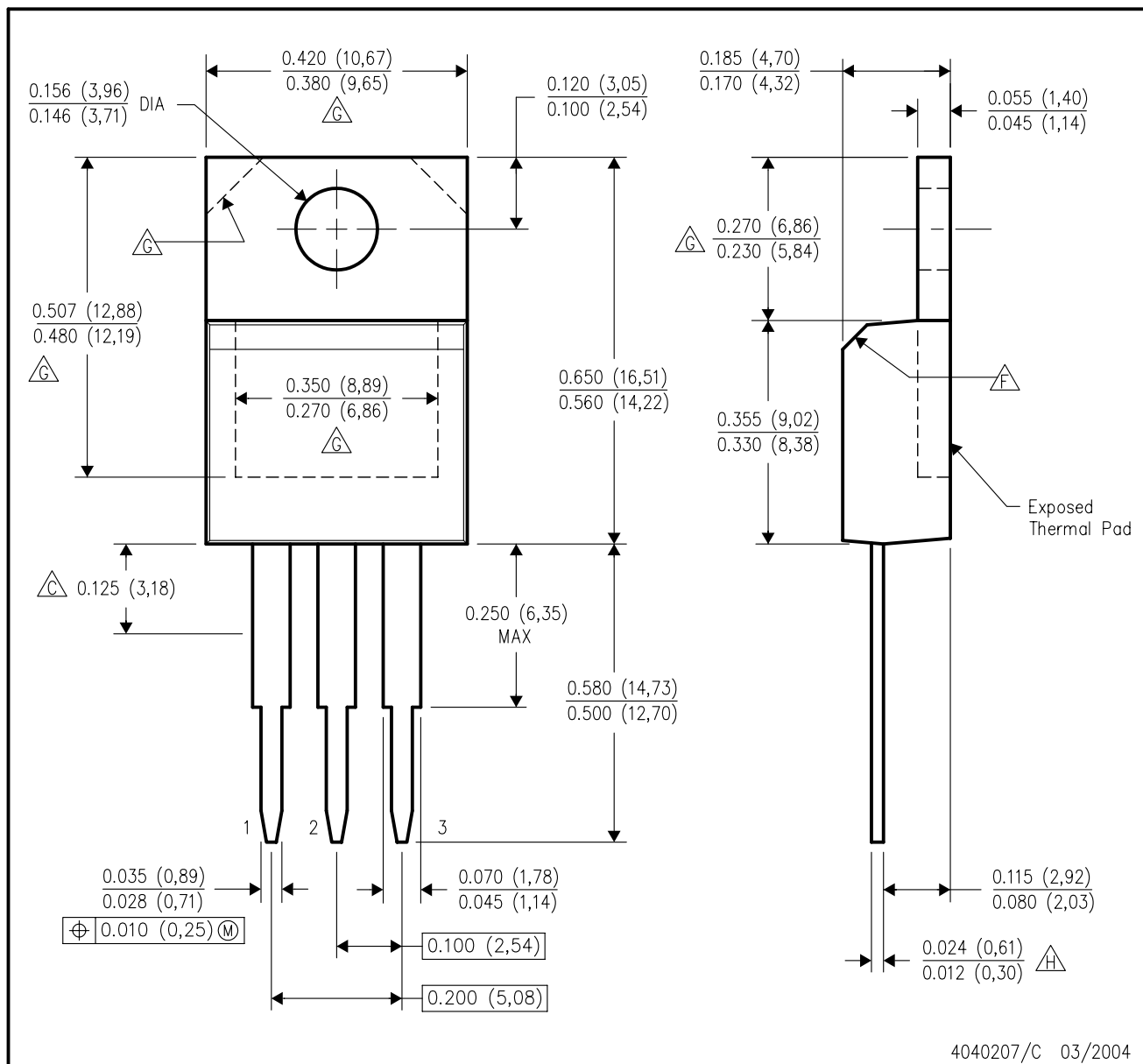
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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KC (R-PSFM-T3)

PLASTIC FLANGE-MOUNT PACKAGE



4040207/C 03/2004

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Lead dimensions are not controlled within this area.
- D. All lead dimensions apply before solder dip.
- E. The center lead is in electrical contact with the mounting tab.
- F. The chamfer is optional.
- G. Thermal pad contour optional within these dimensions.
- H. Falls within JEDEC TO-220 variation AB, except minimum lead thickness.

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 D. Falls within JEDEC MO-153

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